

February 2009

## HI-8282A

ARINC 429

Serial Transmitter and Dual Receiver

## **GENERAL DESCRIPTION**

The HI-8282A is a silicon gate CMOS device for interfacing the ARINC 429 serial data bus to a 16-bit parallel data bus. Two receivers and an independent transmitter are provided. The receiver input circuitry and logic are designed to meet the ARINC 429 specifications for loading, level detection, timing, and protocol. The transmitter section provides the ARINC 429 communication protocol. Additional interface circuitry such as the Holt HI-8585, HI-8586 or HI-3182 is required to translate the 5 volt logic outputs to ARINC 429 drive levels.

The 16-bit parallel data bus exchanges the 32-bit ARINC data word in two steps when either loading the transmitter or interrogating the receivers. The data bus interfaces with CMOS and TTL.

Timing of all the circuitry begins with the master clock input, CLK. For ARINC 429 applications, the master clock frequency is 1 MHz.

Each independent receiver monitors the data stream with a sampling rate 10 times the data rate. The sampling rate is software selectable at either 1MHz or 125KHz. The results of a parity check are available as the 32nd ARINC bit. The HI-8282A examines the null and data timings and will reject erroneous patterns. For example, with a 125 KHz clock selection, the data frequency must be between 10.4 KHz and 15.6 KHz.

The transmitter has a First In, First Out (FIFO) memory to store 8 ARINC words for transmission. The data rate of the transmitter is software selectable by dividing the master clock, CLK, by either 10 or 80. The master clock is used to set the timing of the ARINC transmission within the required resolution.

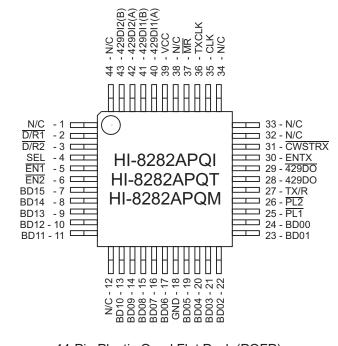
## APPLICATIONS

- Avionics data communication
- Serial to parallel conversion
- Parallel to serial conversion

## FEATURES

- ARINC specification 429 compliant
- Alternate source to Intersil HS-3282 in all ARINC 429 applications
- Small footprint 44-pin QFP package option
- 16-Bit parallel data bus
- Direct receiver interface to ARINC bus
- Timing control 10 times the data rate
- Selectable data clocks
- Automatic transmitter data timing
- 8 word transmit FIFO
- Receiver error rejection per ARINC specification 429
- Self test mode
- Parity functions
- Low power, single 5 volt supply
- Industrial & extended temperature ranges

## PIN CONFIGURATION (Top View)



44-Pin Plastic Quad Flat Pack (PQFP) (See page 10 for additional Package Pin Configurations)

## **PIN DESCRIPTION**

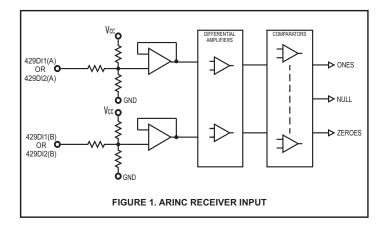
SYMBOL	FUNCTION	DESCRIPTION
VCC	POWER	+5V ±5%
429DI1 (A)	INPUT	ARINC receiver 1 positive input
429DI1 (B)	INPUT	ARINC receiver 1 negative input
429DI2 (A)	INPUT	ARINC receiver 2 positive input
429DI2 (B)	INPUT	ARINC receiver 2 negative input
D/R1	OUTPUT	Receiver 1 data ready flag
D/R2	OUTPUT	Receiver 2 data ready flag
SEL	INPUT	Receiver data byte selection (0 = BYTE 1) (1 = BYTE 2)
EN1	INPUT	Data Bus control, enables receiver 1 data to outputs
EN2	INPUT	Data Bus control, enables receiver 2 data to outputs if $\overline{EN1}$ is high
BD15	I/O	Data Bus
BD14	I/O	Data Bus
BD13	I/O	Data Bus
BD12	I/O	Data Bus
BD11	I/O	Data Bus
BD10	I/O	Data Bus
BD09	I/O	Data Bus
BD08	I/O	Data Bus
BD07	I/O	Data Bus
BD06	I/O	Data Bus
GND	POWER	0 V
BD05	I/O	Data Bus
BD04	I/O	Data Bus
BD03	I/O	Data Bus
BD02	I/O	Data Bus
BD01	I/O	Data Bus
BD00	I/O	Data Bus
PL1	INPUT	Latch enable for byte 1 entered from data bus to transmitter FIFO.
PL2	INPUT	Latch enable for byte 2 entered from data bus to transmitter FIFO. Must follow PL1.
TX/R	OUTPUT	Transmitter ready flag. Goes low when ARINC word loaded into FIFO. Goes high after transmission and FIFO empty.
429DO	OUTPUT	"ONES" data output from transmitter.
429DO	OUTPUT	"ZEROES" data output from transmitter.
ENTX	INPUT	Enable Transmission
CWSTR	INPUT	Clock for control word register
CLK	INPUT	Master Clock input
TX CLK	OUTPUT	Transmitter Clock equal to Master Clock (CLK), divided by either 10 or 80.
MR	INPUT	Master Reset, active low

## FUNCTIONAL DESCRIPTION

#### CONTROL WORD REGISTER

The HI-8282A contains 10 data flip flops whose D inputs are connected to the data bus and clocks connected to CWSTR. Each flip flop provides options to the user as follows:

DATA BUS PIN	FUNCTION	CONTROL	DESCRIPTION
BDO5	SELF TEST	0 = ENABLE	If enabled, an internal connection is made passing 429DO and 429DO to the receiver logic inputs
BDO6	RECEIVER 1 DECODER	1 = ENABLE	If enabled, ARINC bits 9 and, 10 must match the next two control word bits
BDO7	-	-	If Receiver 1 Decoder is enabled, the ARINC bit 9 must match this bit
BDO8	-	-	If Receiver 1 Decoder is enabled, the ARINC bit 10 must match this bit
BDO9	RECEIVER 2 DECODER	1 = ENABLE	If enabled, ARINC bits 9 and 10 must match the next two control word bits
BD10	-	-	If Receiver 2 Decoder is enabled, then ARINC bit 9 must match this bit
BD11	-	-	If Receiver 2 Decoder is enabled, then ARINC bit 10 must match this bit
BD12	INVERT XMTR PARITY	1 = ENABLE	Logic 0 enables normal odd parity and Logic 1 enables even parity output in transmitter 32nd bit
BD13	XMTR DATA CLK SELECT	0 = ÷10 1 = ÷80	CLK is divided either by 10 or 80 to obtain XMTR data clock
BD14	RCVR DTA CLK SELECT	0 = ÷10 1 = ÷80	CLK is divided either by 10 or 80 to obtain RCVR data clock



#### **ARINC 429 DATA FORMAT**

The following table shows the bit positions in exchanging data with the receiver or transmitter. ARINC bit 1 is the first bit transmitted or received.

						E	вүт	E 1								
DATA BUS	BD 15	BD 14	BD 13	BD 12	BD 11	BD 10	BD 09	BD 08	BD 07	BD 06	BD 05	BD 04	BD 03	BD 02	BD 01	BD 00
ARINC BIT	13	12	11	10	9	31	30	32	1	2	3	4	5	6	7	8
							BY1	TE 2	2							
DATA BUS	BD 15	BD 14	BD 13	BD 12	BD 11	BD 10	BY1 BD 09	BD 08	BD 07	BD 06	BD 05	BD 04	BD 03	BD 02	BD 01	BD 00

#### THE RECEIVERS

#### ARINC BUS INTERFACE

Figure 1 shows the input circuit for each receiver. The ARINC 429 specification requires the following detection levels:

<u>STATE</u>	DIFFERENT	<b>IAL</b>	VOLTAGE
ONE	+6.5 Volts	to	+13 Volts
NULL	+2.5 Volts	to	-2.5 Volts
ZERO	-6.5 Volts	to	-13 Volts

The HI-8282A guarantees recognition of these levels with a common mode Voltage with respect to GND less than  $\pm 5V$  for the worst case condition (4.75V supply and 13v signal level).

Design tolerances guarantee detection of the above levels, so the actual acceptance ranges are slightly larger. If the ARINC signal is out of the actual acceptance ranges, including the nulls, the chip rejects the data.

#### HI-8282A-10

The HI-8282A-10 option is similar to the HI-8282A with the exception that it allows an external 10K to 15K ohm resistor to be added in series with each ARINC input without affecting the ARINC input thresholds. This option is especially useful in applications where lightning protection circuitry is also required.

Each side of the ARINC bus must be connected through a 10K to 15K ohm series resistor in order for the chip to detect the correct ARINC levels. The typical 10 volt differential signal is translated and input to a window comparator and latch. The comparator levels are set so that with the external 10K to 15K ohm resistors, they are just below the standard 6.5 V minimum ARINC data threshold and just above the 2.5 V maximum ARINC null threshold.

The receivers of the HI-8282A-10, when used with external 15K ohm resistors, will withstand DO-160F, Level 3, waveforms 3, 4, 5A and 5B pin injection. No additional lightning protection circuit is necessary.

Please refer to the Holt AN-300 Application Note for additional information and recommendations on lightning protection of Holt Line Drivers and Receivers.

#### **RECEIVER LOGIC OPERATION**

Figure 2 (next page) is a block diagram for each receiver's logic.

## **FUNCTIONAL DESCRIPTION (cont.)**

#### **BIT TIMING**

The ARINC 429 specification defines the following timing tolerances for received data:

	<u>HIGH SPEED</u>	LOW SPEED
BIT RATE	100K BPS ± 1%	12K -14.5K BPS
PULSE RISE TIME	1.5 ± 0.5 µsec	10 ± 5 µsec
PULSE FALL TIME	1.5 ± 0.5 µsec	10 ± 5 µsec
PULSE WIDTH	5 µsec ± 5%	34.5 to 41.7 µsec

The HI-8282A accepts signals within these tolerances and rejects signals outside these tolerances. Receiver logic achieves this as described below:

1. An accurate 1MHz clock source is required to validate receive signal timing. Less than 0.1% error is recommended.

2. The receiver uses three separate 10-bit sampling shift registers for Ones detection, Zeros detection and Null detection. When the input signal is within the differential voltage range for any shift register's state (One Zero or Null) sampling clocks a high bit into that register. When the receive signal is outside the differential voltage range defined for any shift register, a low bit is clocked. Only one shift register can clock a high bit for any given sample. All three registers clock low bits if the differential input voltage is between defined state voltage bands. Valid data bits require at least three consecutive One or Zero samples (three high bits) in the upper half of the Ones or Zeros sampling shift register, and at least three consecutive Null samples (three high bits) in the lower half of the Null sampling shift register within the data bit interval. A word gap Null requires at least three consecutive Null samples (three high bits) in the upper half of the Null sampling shift register and at least three consecutive Null samples (three high bits) in the lower half of the Null sampling shift register. This guarantees the minimum pulse width.

3. To validate the receive data bit rate, each bit must follow its preceding bit by not less than 8 samples and not more than 12 samples. With exactly 1MHz input clock frequency, the acceptable data bit rates are

	<u>HIGH SPEED</u>	LOW SPEED
DATA BIT RATE MIN	83K BPS	10.4K BPS
DATA BIT RATE MAX	125K BPS	15.6K BPS

4. Following the last data bit of a valid reception, the Word Gap timer samples the Null shift register every 10 input clocks (every 80 clocks for low speed). If a Null is present, the Word Gap counter is incremented. A Word Gap count of 3 enables the next reception.

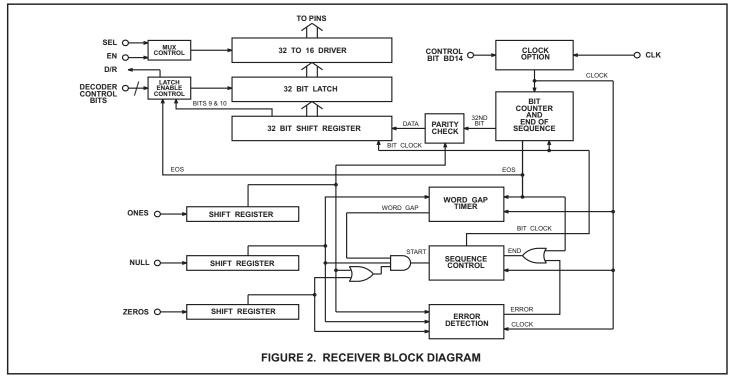
#### **RECEIVER PARITY**

The receiver parity circuit counts Ones received, including the parity bit. If the result is odd, a "0" appears in the 32nd bit.

#### **RETRIEVING DATA**

Once 32 valid bits are recognized, the receiver logic generates an End of Sequence (EOS). If the receiver decoder is enabled and the 9th and 10th ARINC bits match the control word program bits or if the receiver decoder is disabled, then EOS clocks the data ready flag flip flop to a "1",  $\overline{D/R1}$  or  $\overline{D/R2}$  (or both) will go low. The data flag for a receiver will remain low until after both ARINC bytes from that receiver are retrieved. This is accomplished by activating  $\overline{EN}$  with SEL, the byte selector, low to retrieve the first byte and activating  $\overline{EN}$  with SEL high to retrieve the second byte.  $\overline{EN1}$  retrieves data from receiver 1 and  $\overline{EN2}$  retrieves data from receiver 2.

If another ARINC word is received and a new EOS occurs before the two bytes are retrieved, the data is overwritten by the new word.



## **FUNCTIONAL DESCRIPTION (cont.)**

#### TRANSMITTER

A block diagram of the transmitter section is shown in Figure 3.

#### **FIFO OPERATION**

The FIFO is loaded sequentially by first pulsing  $\overline{PL1}$  to load byte 1 and then  $\overline{PL2}$  to load byte 2. The control logic automatically loads the 31 bit word in the next available position of the FIFO. If TX/R, the transmitter ready flag, is high (FIFO empty), then 8 words, each 31 bits long, may be loaded. If TX/R is low, then only the available positions may be loaded. If all 8 positions are full, the FIFO ignores further attempts to load data.

#### DATA TRANSMISSION

When ENTX goes high, enabling transmission, the FIFO positions are incremented with the top register loading into the data transmission shift register. Within 2.5 data clocks the first data bit appears at either 429DO or 429DO. The 31 bits in the data transmission shift register are presented sequentially to the outputs in the ARINC 429 format with the following timing:

	HIGH SPEED	LOW SPEED
ARINC DATA BIT TIME	10 Clocks	80 Clocks
DATA BIT TIME	5 Clocks	40 Clocks
NULLBITTIME	5 Clocks	40 Clocks
WORD GAP TIME	40 Clocks	320 Clocks

The word counter detects when all loaded positions are transmitted and sets the transmitter ready flag, TX/R, high.

#### **TRANSMITTER PARITY**

The parity generator counts the ONES in the 31-bit word. If the

BD12 control word bit is set low, the 32nd bit transmitted will make parity odd. If the control bit is high, the parity is even.

#### SELF TEST

If the BD05 control word bit is set low, 429DO or  $\overline{429DO}$  are internally connected to the receivers inputs, bypassing the interface circuitry. Data to Receiver 1 is as transmitted and data to Recevier 2 is the complement. 429DO and  $\overline{429DO}$  outputs remain active during self test.

#### SYSTEM OPERATION

The two receivers are independent of the transmitter. Therefore, control of data exchanges is strictly at the option of the user. The only restrictions are:

1. The received data may be overwritten if not retrieved within one ARINC word cycle.

2. The FIFO can store 8 words maximum and ignores attempts to load addition data if full.

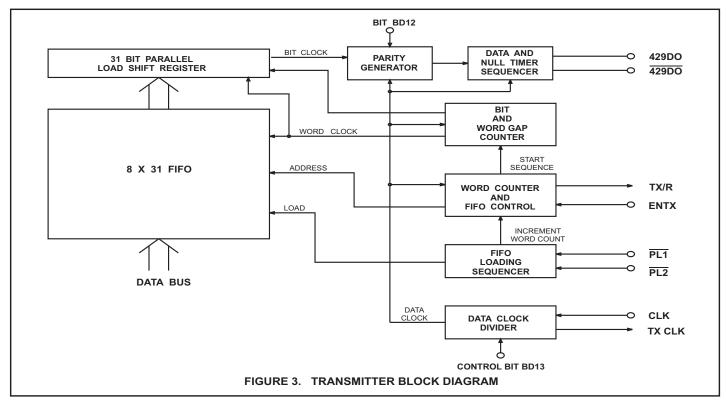
3. Byte 1 of the transmitter data must be loaded first.

4. Either byte of the received data may be retrieved first. Both bytes must be retrieved to clear the data ready flag.

5. After ENTX, transmission enable, goes high it cannot go low until TX/R, transmitter ready flag, goes high. Otherwise, one ARINC word is lost during transmission.

#### MASTER RESET (MR)

Upon Master Reset, data transmission and reception are immediately terminated, the transmit FIFO and receivers cleared as are the transmit and receive flags. The Control Word register is not affected by a Master Reset.



## **FUNCTIONAL DESCRIPTION (cont.)**

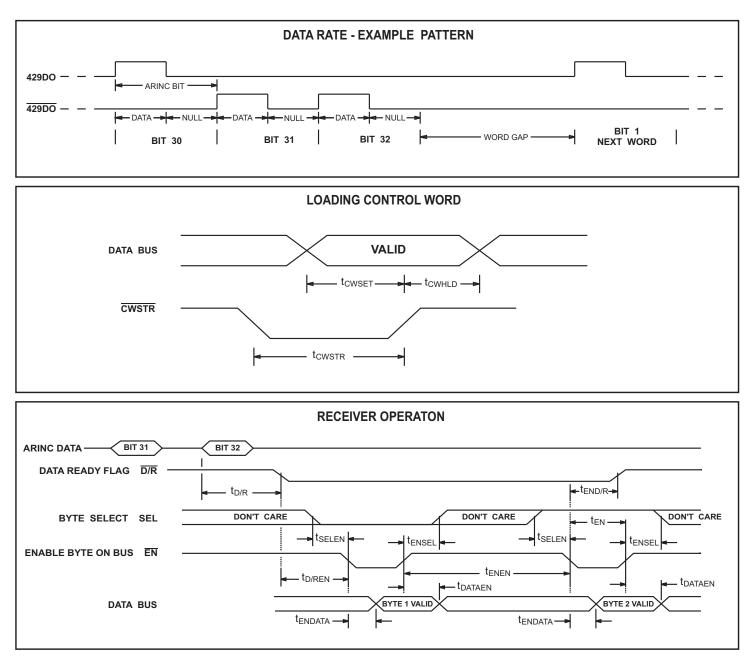
#### **REPEATER OPERATION**

Repeater mode of operation allows a data word received by the HI-8282 to be placed directly into the Transmit FIFO for transmission. After a 32-bit word has been shifted into the receiver shift register, the  $\overline{D/R}$  flag goes low. A logic "0" is placed on the SEL line and  $\overline{EN}$  is strobed. This is the same procedure as for normal receiver operation, placing the lower byte (16) of the data word on the data bus. By strobing  $\overline{PL1}$  at the same time as  $\overline{EN}$ , the byte is also transferred into the Transmit FIFO. SEL is then taken high and  $\overline{EN}$  is strobed again to place the upper data

word byte onto the data bus. By strobing  $\overline{PL2}$  at the same time as  $\overline{EN}$ , the second data word byte is also transferred to the Transmit FIFO. The data word is now ready for transmission, according to the parity programmed into the Control Word register.

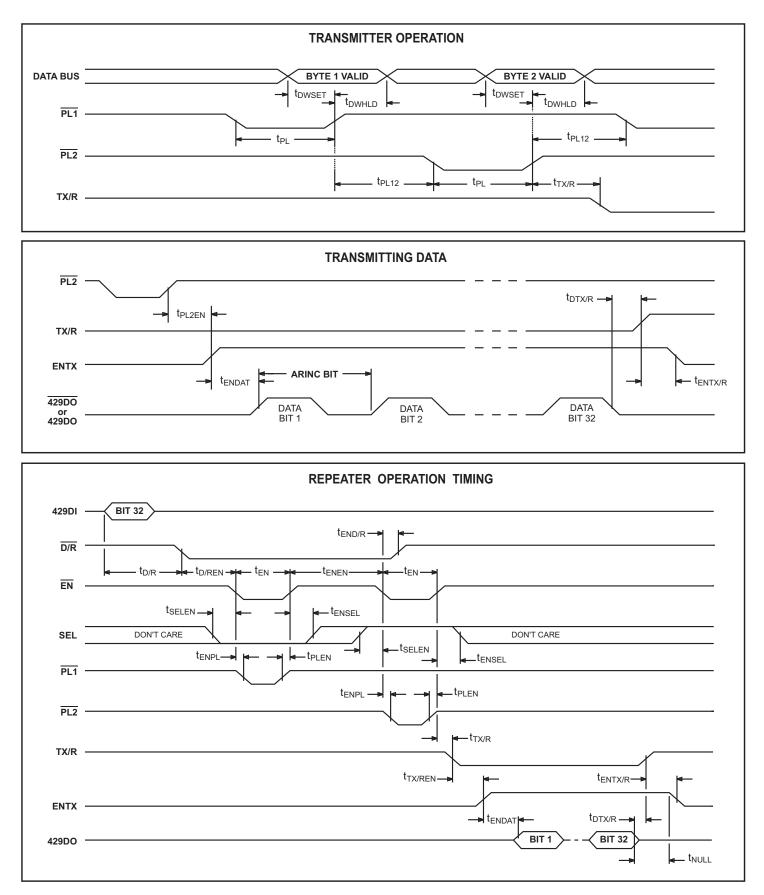
In normal (non-repeater) operation, either byte of the received data word may be read first by using the SEL input. During repeater operation however, data word lower byte must always be read first. While the data is being read, it is loading concurrently into the Transmit FIFO, which always loads lower byte first.

## **TIMING DIAGRAMS**



#### HI-8282A

## **TIMING DIAGRAMS (cont.)**



## **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage Vcc ····· -0.3V to +7V	Power Dissipation · · · · · · · 500mW
Voltage at ARINC Inputs · · · · · · · · · · · · · · · · · · ·	Operating Temperature Range: (Industrial) · · · · · -40°C to +85°C
Voltage at any other pin · · · · · · · · · · · · · · · · · · ·	(Hi-Temp) · · · · · -55°C to +125°C
DC Current Drain per input pin · · · · · · · · · 10mA	Storage Temperature Range: ••••••••••••-65°C to +150°C

NOTE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## DC ELECTRICAL CHARACTERISTICS

Vcc = 5V ±5%, GND = 0V, TA = Operating Temperature Range (unless otherwise specified).

PARAMET	ER	SYMBOL	CONDITIONS		LIMITS		UNIT
				MIN	TYP	MAX	
ARINC INPUTS - 429DI1 (A),	429DI1 (B), 429DI2 (A) & 429D	I2 (B)					
Differential Input Voltage:	ONE ZERO NULL	Vih Vil Vnul	ARINC Input Pins: Common mode voltage less than ±5V with respect to GND	6.5 -13.0 -2.5	10.0 -10.0 0	13.0 -6.5 2.5	V V V
Input Resistance:	Differential To GND To Vcc	Rı Rg Rн		12 12 12	27 27		ΚΩ ΚΩ ΚΩ
Input Current:	Input Sink Input Source	liн li∟		-450		200	μΑ μΑ
Input Capacitance: (Guaranteed but not tested)	Differential To GND To Vcc	Сі Сд Сн	Pins 2 to 3, 4 to 5			20 20 20	pF pF pF
BI-DIRECTIONAL INPUTS - BD	00 through BD15						
Input Voltage:	Input Voltage HI Input Voltage LO	Vih Vil		2.1		0.7	V V
Input Current:	Input Sink Input Source	liн li∟		-1.5		1.5	μA μA
ALL OTHER INPUTS - SEL, EN	1, EN2, PL1, PL2, ENTX, CWS1	<b>FR</b> , CLK & <b>M</b>	R				
Input Voltage:	Input Voltage HI Input Voltage LO	Vih Vil		3.5		0.7	V V
Input Current:	Input Sink Input Source	lıн lı∟		-20		10	μΑ μΑ
OUTPUTS - $\overline{D/R1}$ , $\overline{D/R2}$ , BD00	through BD15, TX/R, 429DO, $\overline{4}$	29DO & TX	CLK				
Output Voltage:	Logic "1" Output Voltage Logic "0" Output Voltage	Vон Vol	Іон = -1.5mA Іо∟ = 2.6mA	2.7		0.4	V V
Output Current: (Bi-directional Pins)	Output Sink Output Source	Iol Ioн	Vout = 0.4V Vout = Vcc - 0.4V	3.0 1.1			mA mA
Output Current: (All Other Outputs)	Output Sink Output Source	Iol Ioн	Vout = 0.4V Vout = Vcc - 0.4V	2.6 1.1			mA mA
Output Capacitance:		Co				15	pF
SUPPLY INPUT - Vcc							
Standby Supply Current:		Icc1				20	mA
Operating Supply Current:		ICC2				20	mA

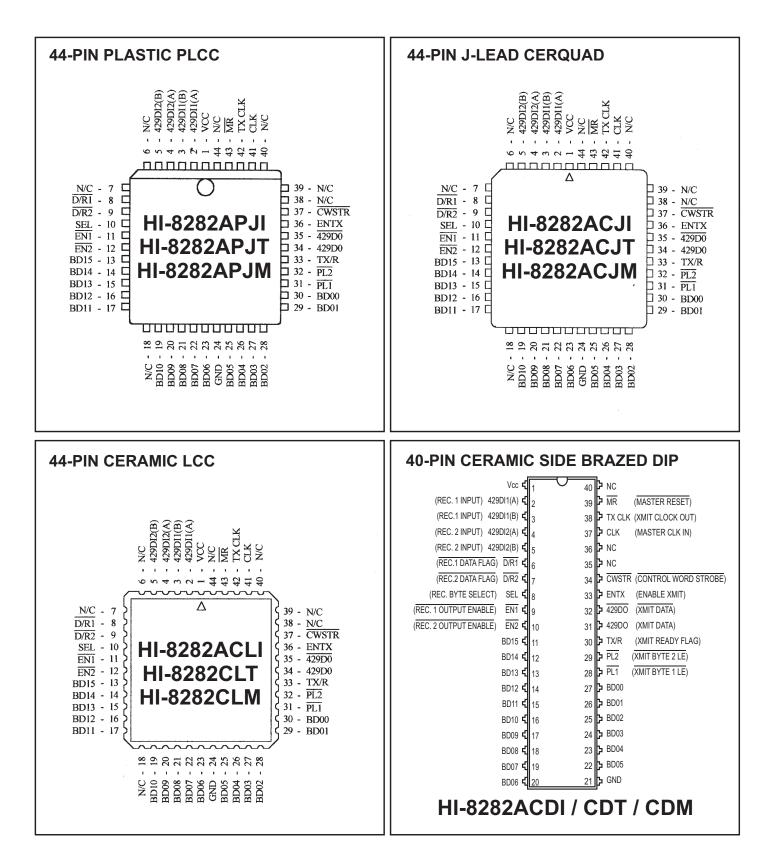
## AC ELECTRICAL CHARACTERISTICS

Vcc = 5V, GND = 0V, TA = Operating Temperature Range and fclk = 1MHz +0.1% with 60/40 duty cycle

DADAMETER	OVMDOI		LIMITS		
PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNITS
CONTROL WORD TIMING					
Pulse Width - CWSTR Setup - DATA BUS Valid to CWSTR HIGH Hold - CWSTR HIGH to DATA BUS Hi-Z	tcwstr tcwset tcwhld	130 130 0			ns ns ns
RECEIVER TIMING		· · ·		•	<u>.</u>
Delay - Start ARINC 32nd Bit to D/R LOW: High Speed Low Speed	tD/R tD/R			16 128	μs μs
Delay - D/R LOW to EN L0W Delay - EN LOW to D/R HIGH	tD/REN tend/R	0		200	ns ns
Setup - SEL to <del>EN</del> L0W Hold - SEL to <del>EN</del> HIGH	tselen tensel	20 20			ns ns
Delay - EN L0W to DATA BUS Valid Delay - EN HIGH to DATA BUS Hi-Z	tendata tdataen			200 30	ns ns
Pulse Width - EN1 or EN2 Spacing - EN HIGH to next EN LOW	ten tenen	200 50			ns ns
FIFO TIMING				·	
Pulse Width - PL1 or PL2	tPL	200			ns
Setup - DATA BUS Valid to PL HIGH Hold - PL HIGH to DATA BUS Hi-Z	tdwset tdwhld	110 10			ns ns
Spacing - PL1 or PL2	tPL12	0			ns
Delay - PL2 HIGH to TX/R LOW	ttx/R			840	ns
TRANSMISSION TIMING					
Spacing - PL2 HIGH to ENTX HIGH	tPL2EN	0			μs
Delay - ENTX HIGH to TXA(OUT) or TXB(OUT): High Speed Delay - ENTX HIGH to TXA(OUT) or TXB(OUT): Low Speed	tendat tendat			25 200	μs μs
Delay - 32nd ARINC Bit to TX/R HIGH	tdtx/R			400	ns
Spacing - TX/R HIGH to ENTX L0W	tentx/R	0			ns
REPEATER OPERATION TIMING					_
Delay - EN LOW to PL LOW	tenpl	0			ns
Hold - PL HIGH to EN HIGH	<b>t</b> PLEN	0			ns
Delay - TX/R LOW to ENTX HIGH	ttx/ren	0			ns
Master Reset Pulse Width	tmr	200			ns
ARINC Data Rate and Bit Timing				± 1%	

## ADDITIONAL HI-8282A PIN CONFIGURATIONS

(See page 1 for the 44-pin Plastic Quad Flat Pack )



### **ORDERING INFORMATION**

## HI - 8282A <u>Cx x</u> -<u>xx</u> (Ceramic)

	PART		INPUT	S	ERIES RE	SISTANCE			
	NUMBER		BUILT-IN		REQUIRE		IALLY		
	No dash nu	ımber	35 Kohm			0			
	-10 (	Note 1)	25 Kohm		10K	to 15K ohn	n		
	PART NUMBER	TEMP	PERATURE GE		FLOW	BURN IN	LEAD FINISH		
	I	-40°	C TO +85°C		Ι	NO	Gold		
	Т	-55°	C TO +125°C	;	Т	NO	Gold		
	М	-55°	C TO +125°C	;	М	YES	Tin / Le	ead (Sr	n / Pb) Solder
	PART NUMBER		AGE CRIPTION						
	CD	40 PI	N CERAMIC	; SI	IDE BRAZ	ZED DIP (4	0C)		
	CJ	44 PI	N J-LEAD C	ER	QUAD (4	4U)			
	CL	44 PI	N CERAMIC	; LE	EADLESS	CHIP CA	RRIER (	44S)	

## HI - 8282A <u>Px x x -xx</u> (Plastic)

PART		INPUT	INPUT SERIES RESISTANCE					
NUMBER		BUILT-IN REQUIRED EXTERN			NALLY			
No dash nu	Imber	35 Kohm	im 0					
-10 (	Note 1)	25 Kohm	10K	to 15K ohm	۱			
PART NUMBER	LEAD							
Blank	Tin /	Lead (Sn / Pb	) Solder					
F	100%	00% Matte Tin (Pb-free, RoHS compliant)						
				/				
PART NUMBER	TEMF RANG	PERATURE GE	FLOW	BURN IN				
I	-40°	C TO +85°C	I	NO				
Т	-55°	C TO +125°C	Т	NO				
М	-55°	C TO +125°C	М	YES				
PART	PART PACK NUMBER DESC				-			
NUMBER				14 PIN PLASTIC J-LEAD PLCC (44J)				
PJ		N PLASTIC J	I-LEAD PLO	CC (44J)				

NOTES:

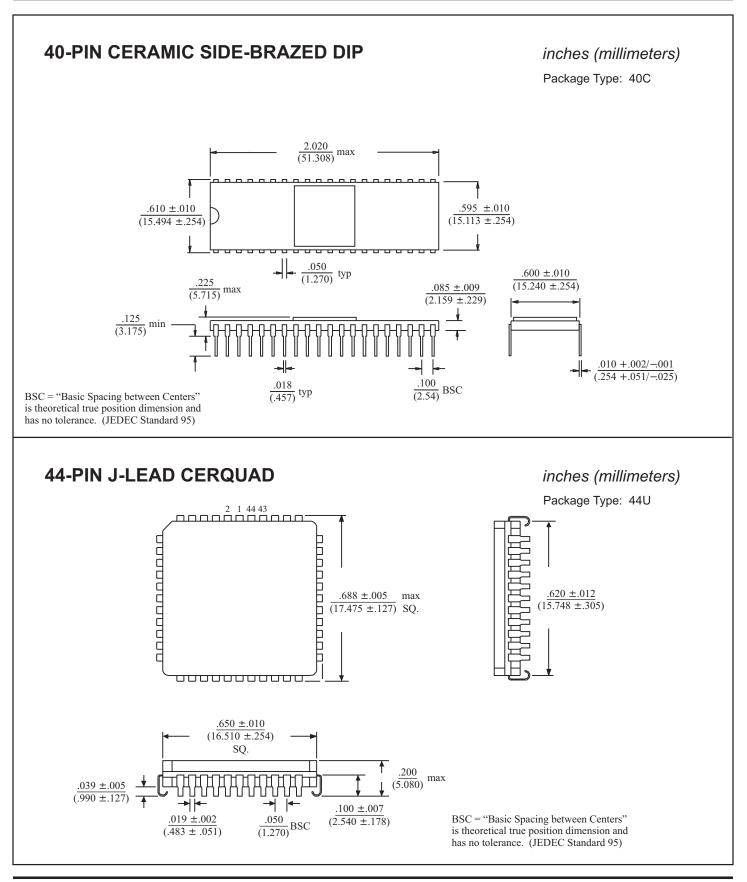
 The -10 configuration requires an external 10K to 15K ohm resistor in series with each ARINC input to guarantee specified voltage thresholds. The 15K ohm resistors are required to withstand DO-160F, Level 3, Waveforms 3, 4, 5A & 5B pin injection.

## **REVISION HISTORY**

Revision	Date	Description of Change
DS8282A, Rev. G	02/01/09	Clarified the "T" temperature range. Clarified series resistance values for "-10" devices.

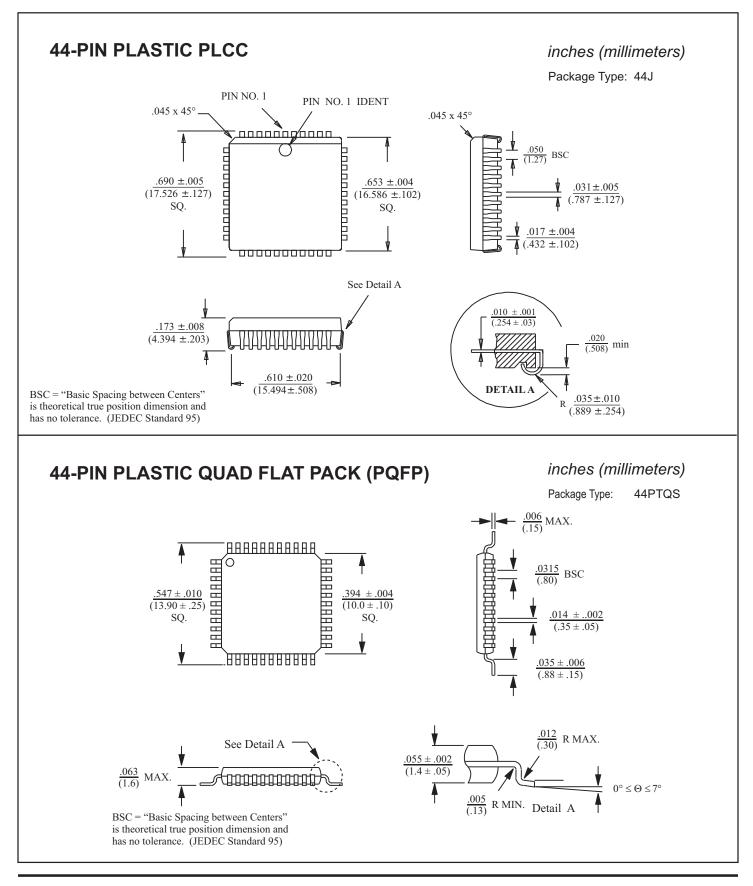
# HOLT Z

## **HI-8282A PACKAGE DIMENSIONS**





## **HI-8282A PACKAGE DIMENSIONS**



## HOLT INTEGRATED CIRCUITS

## **HI-8282A PACKAGE DIMENSIONS**

